



# **BAS116**

## SURFACE MOUNT LOW LEAKAGE DIODE

### **Features**

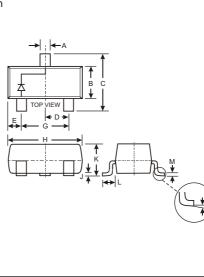
Surface Mount Package Ideally Suited for Automatic Insertion Very Low Leakage Current

#### Lead Free/RoHS Compliant (Note 3)

## **Mechanical Data**

Case: SOT-23

Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020C Terminal Connections: Solderable per MIL-STD-202, Method 208 Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Polarity: See Diagram Marking: K50, K54 (See Page 3) Weight: 0.008 grams (approximate)



SOT-23								
Dim	Min	Max						
Α	0.37	0.51						
В	1.20	1.40						
С	2.30	2.50						
D	0.89	1.03						
Е	0.45	0.60						
G	1.78	2.05						
н	2.80	3.00						
J	0.013	0.10						
к	0.903	1.10						
L	0.45	0.61						
М	0.085	0.180						
	0	8						
All Din	nensions	in mm						

#### Maximum Ratings @ TA = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	85	V	
RMS Reverse Voltage	V <sub>R(RMS)</sub>	60	V	
Forward Continuous Current (Note 1)	I <sub>FM</sub>	215	mA	
Repetitive Peak Forward Current	I <sub>FRM</sub>	500	mA	
Non-Repetitive Peak Forward Surge Current $@ t = 1.0 s$ @ t = 1.0ms @ t = 1.0ms	I <sub>FSM</sub>	4.0 1.0 0.5	A	

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit		
Power Dissipation (Note 1)	Pd	250	mW		
Thermal Resistance Junction to Ambient Air (Note 1)	R <sub>JA</sub>	500	C/W		
Operating and Storage Temperature Range	Тј, Т <sub>STG</sub>	-65 to +150	С		

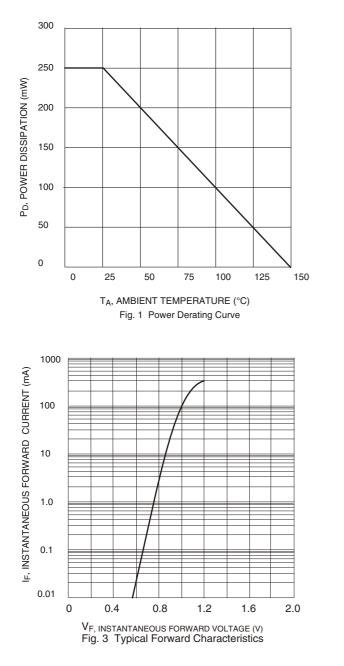
#### Electrical Characteristics @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition		
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	85			V	I <sub>R</sub> = 100 A		
Forward Voltage	V <sub>FM</sub>			0.90 1.0 1.1 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA		
Leakage Current (Note 2)	I <sub>RM</sub>			5.0 80	nA nA	$V_R = 75V$ $V_R = 75V$ , $T_j = 150$ C		
Total Capacitance	Ст		2		pF	V <sub>R</sub> = 0, f = 1.0MHz		
Reverse Recovery Time	t <sub>rr</sub>			3.0	S	$\label{eq:lf} \begin{array}{l} I_F = I_R = 10 m A, \\ I_{rr} = 0.1 \ x \ I_R, \ R_L = 100 \end{array}$		

Notes: 1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. T<sub>A</sub> = 25 C.

- Short duration test pulse used to minimize self-heating effect.
- 3. No Purposefully added Lead.





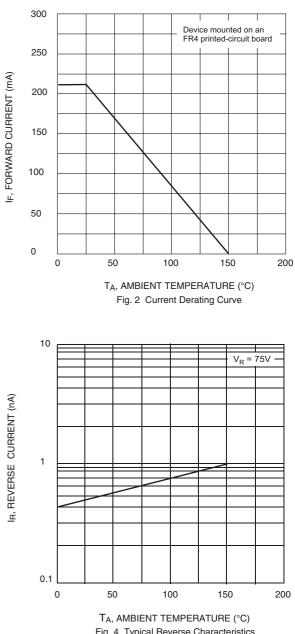


Fig. 4 Typical Reverse Characteristics

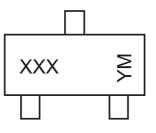
## DECES.

## Ordering Information (Note 4)

Device	Packaging	Shipping
BAS116-7-F	SOT-23	3000/Tape & Reel

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



 $\begin{array}{l} XXX = \mbox{Product Type Marking Code (See Page 1)} \\ YM = \mbox{Date Code Marking} \\ Y = \mbox{Year ex: } N = 2002 \\ M = \mbox{Month ex: } 9 = \mbox{September} \end{array}$ 

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

#### IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

#### LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.